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DATA SHEET

ESL NO.: ESS-5730UWDT-R80-WR

CUS NO.:

REV: A/0

Producer: <u>我常</u> Auditor: <u>张</u> Approver: 近

CUSTOMER'S APPROVAL : ______ DCC : ____

Page: 1 DATE: 2014-07-01 DRAWING NO.: ESS-DS-23-14-0013

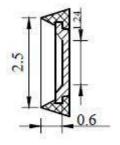


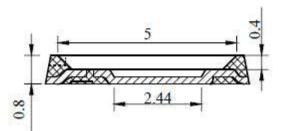
ESS-5730UWDT-R80-WR

REV:A/0

PACKAGE DIMENSIONS

2 5.4 5.7







Note:

- 1. All Dimensions are in millimeters.
- 2. Tolerance is $\pm 0.25 mm$ (0.010 "). Unless otherwise specified.



ESS-5730UWDT-R80-WR

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Absolute maximum	ratings					Ta:	=25	°C)
Parameter			Symbol		Value			Unit
Forward current			If		150			mA
Reverse voltage			Vr		5			V
Power dissipation				Pd		00		MW
Operating temperature range			Тор		-40~+85)°C
Storage temperature range			-	Tstg -40~		+100		°C
Peak pulsing current (1/8 duty f=1KHz)				lfp	300			mA
Electro-Optical characteristics (TA=25°C						°C)		
Parameter	Test Condition				Value			
		Symb	ool	Min	Тур	Max	Unit	
Color Temperature	If=150mA	CC-	Γ	4700		7000		K
Forward voltage	If=150mA	Vf		3.0		3.6		V
Light	lf=150mA	φ		55		65		Lm
Color Rendering Index	If=150mA	CR	l	80				1
Viewing angle at 50% IV		2 0 1/2			120		[Deg
Reverse current	Vr=5V	lr			10			μ Α

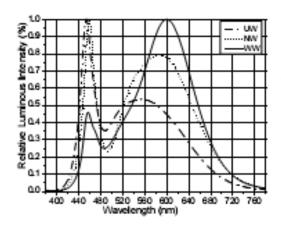


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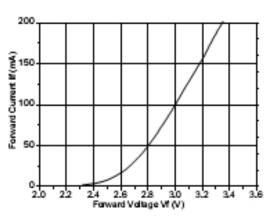
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Typical photo electricity characteristic curve chart

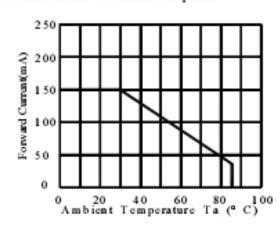
Relative Luminous Intensity Vs. Wavelength Ta=25°C



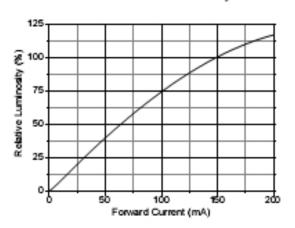
Forward Current vs Forward Voltage at Ta=25 °C



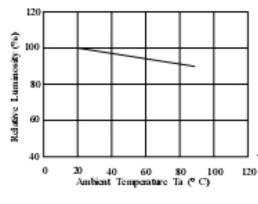
Forward Current Vs. Ambient Temperture



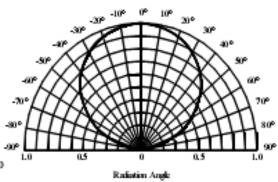
Forward Current Vs.Relative Luminosity Ta=25°C



Relative Luminosity Vs. Ambient Temperature



Radiation diagram



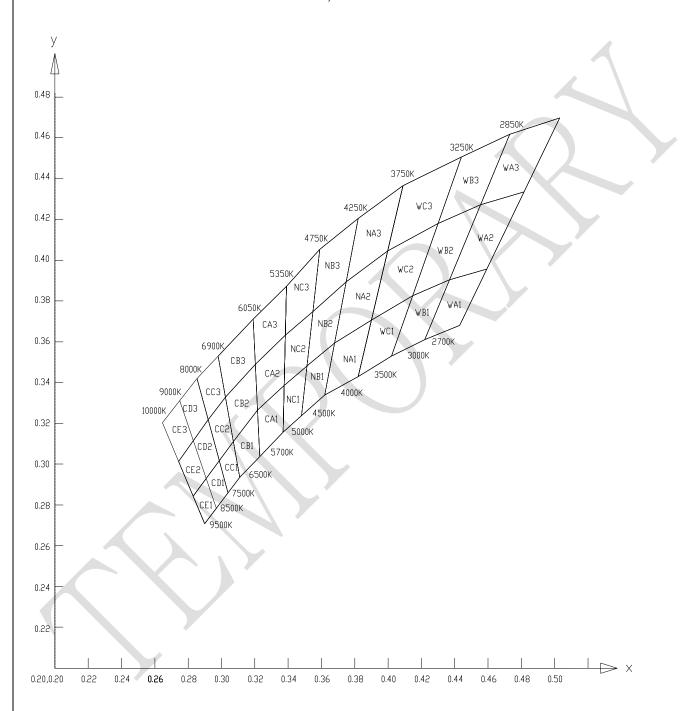


ESS-5730UWDT-R80-WR

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Typical photo electricity characteristic curve chart

CIE 1931 xy CHROMATICETY DIAGRAM





ESS-5730UWDT-R80-WR

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****BIN** range

Forward voltage (tolerance is ± 0.05 V @ IF=150mA):

BIN CODE	Min. (V)	Max. (V)
S	2.9	3.0
Т	3.0	3.1
U	3.1	3.2
V	3.2	3.3
W	3.3	3.4
X	3.4	3.5

Luminous intensity (tolerance is $~\pm\,10\%$ @ IF=150mA):

BIN CODE	Min.(lm)	Max.(lm)		
B13	50	55		
B14	55	60		
B15	60	65		

X Reliability test items and conditions:

No.	Test Item	Test Conditions	Sample size	Ac/Re
1	Operation Life	Test If=DC60mA Temp: Room temperature Test time=1000hrs	22	0/1
2	High Temperature High Humidity	Temp. =+85℃ RH=85%HR Test time=1000hrs	22	0/1
3	Thermal Shock	-35℃ ~ +85℃ 20min 10s 20min Test Time=300cycles	22	0/1
4	High Temperature Storage	High Temp. =+85℃ Test time=1000hrs	22	0/1
5	Low Temperature Storage	Low Ta=-35℃ Test time=1000hrs	22	0/1
6	Temperature Cycle	-35℃ ~ +100℃ 15min 5min 15min Test Time=300cycle	22	0/1
7	Reflow Soldering	Operation heating: 240 °C (Max.), within 10seconds. (Max.)	22	0/1

X Judgment criteria of failure for the reliability

- Iv: Below 50% of initial values
- Vf: Over 20% of upper limit value
- IR: Over 2 times of upper limit value



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Precautions for use :

- 1. Customer must apply the current limiting resistor in the circuit so as to drive the LEDs within the rated current. Otherwise slight voltage shift maybe will cause big current change and burn out will happen.
- 2. Also, caution should be taken not to overload the LEDs with instantaneous high voltage at the turning ON and OFF of the circuit.
- 3. Storage:
- 3.1 Don't open the moisture proof bag before ready to use the LEDs.
- 3.2 The LEDs should be kept at 30°C or less and 60%RH or less before opening the

package.

The max. storage period before opening the package is 1 year.

3.3 After opening the package, the LEDs should be kept at 30℃/35%RH or less, and it

should

be used within 7 days.

3.4 If the LEDs be kept over the conditions of 3.4, baking is required before mounting.

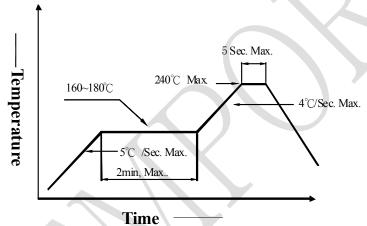
Baking

condition as below: $60\pm5^{\circ}$ C for 12 hrs.

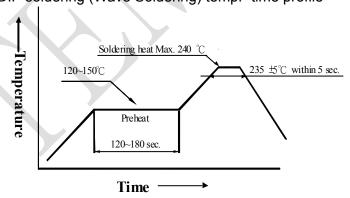
- 4. Soldering condition:
 - 4.1 Manual of soldering:

The temp. of the iron should be lower than 260 $^{\circ}$ C and soldering within 3sec per solder-pad is to be observed.

4.2 Pb-free solder temp. -time profile



4.3 DIP soldering (Wave Soldering) temp. -time profile



Note:

- a) Reflow soldering should not be done more than two times.
- b) Don't put stress on the LEDs when soldering.
- c) Don't warp the circuit board before it have been returned to normal ambient conditions after soldering.

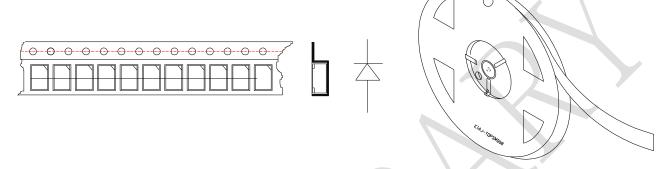


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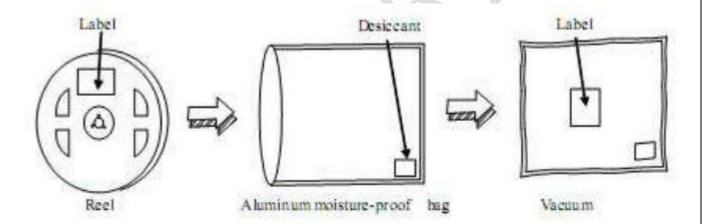
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Tape and Packaging

1 \ Tape leader and reel (1000±3 pcs/Reel)



2 · Packing



3 · Storage:

- 1) Don't open the moisture proof bag before the products are ready to use •
- 2) Before opening the packing, the LED should be kept at 30°C or less and 90RH or less
- 3) After opening the moisture proof bag, should use the LED immediately, do not expose the led in air for a week.
- 4) If the LEDs exceed the storage time or the moisture absorbability material has faded away, Backing treatment should be performed using the following conditions: 60+/-5°C for 24 hours.